ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distrib												
Supplier Information														
Company name* Company unique ID				ique ID	ID		Unique ID Authority			Respon	Response Date*			
onsemi											2024-04-19			
Contact Name Title - Contact				act			Phone - Contact*			Email	Email - Contact*			
Product-Env-Stewards Product Enviro Compliance				ro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative				sentative		Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type		
		MT9M034I12STM- 1.2 MP 1/3 CIS DRBR				2024-04-19		TA1		240.0	mg	Each		
Manufacturing Proccess Information														
	Terminal Plating / Grid Array Materi	ing / Grid Array Material Terminal Base Alloy J-S		J-STD-020 MSI	L Rating Peak Process Body Temperature Max Time at			rature Max Time at Pea	eak Temperature Number of Reflow Cycles					
	Precious metal (e.g. Ag,Au, NiPdA Sn)	u) (no C	CU Alloy 4		4		260	C	30	seco	onds 3			
Comments														
			·					·		·	·			
For more	information regarding material con	nposition	please refer to	page 3	·			·		·	·			

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct at it in member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	50.57	mg		Misc.	proprietary data		0.1922	mg
			Supplier	Silicon (Si)	7440-21-3		49.8772	mg
			Supplier	Aluminum (Al)	7429-90-5		0.5006	mg
Die Attach	1.78	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.6675	mg
			Supplier	Ethylene Glycol	107-21-1		0.0178	mg
			Supplier	Sulfonium (Thiodi-4,1-phenylene)	89452-37-9		0.0534	mg
			Supplier	Modified Silicon Dioxide (SiO2)	67762-90-7		0.3738	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.6675	mg
Imaging Lens	50.18	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		2.509	mg
			Supplier	Sodium Monoxide (Na2O)	1313-59-3		2.509	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		2.509	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		2.509	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.2509	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2.509	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		2.509	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		34.8751	mg
Lid Attach	2.35	mg	Supplier	2-phenoxy ethyl acrylate	48145-04-6		1.0575	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.47	mg
			Supplier	Filler (SiO2)	68909-20-6		0.2937	mg
			Supplier	Acrylate Oligomer	Proprietary Data		0.0117	mg
			Supplier	Curative	Proprietary Data		0.047	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.47	mg
Mold Compound-Black	53.81	mg		Phenolic Resin	proprietary data		8.0715	mg
			Supplier	Oxirane	39817-09-9		8.0715	mg
			Supplier	1,4-Bis(2,3-epoxypropoxy)butane	2425-79-8		1.6143 mg	mg
			Supplier	Carbon Black (C)	1333-86-4		0.5381	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		34.4384	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.0762	mg
Substrate and Solder Mask	81.05	mg	Supplier	Acetophenone	98-86-2		1.5886	mg
			Supplier	Fiber Glass (SiO2)	65997-17-3		17.985	mg
			Supplier	Inorganic Filler of Solder Mask_Talc (Mg3Si4O10(OH)2)	14807-96-6		1.0618	mg

			Supplier	Silica Amorphous (SiO2)	7631-86-9	1.0699	mg
			Supplier	Carbon Black (C)	1333-86-4	0.2675	mg
			Supplier	2,4-Diethyl-9H-thioxanthen-9-one (DETX)	82799-44-8	0.2675	mg
			Supplier	Solvent Naphtha (Solvent oil)	64742-94-5	3.1772	mg
			Supplier	Bismaleimide Triazine resin	Proprietary Data	8.105	mg
			Supplier	Copper (Cu)	7440-50-8	39.3093	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7	8.2185	mg
Wire Bond - Au	0.26	mg	Supplier	Gold (Au)	7440-57-5	0.26	mg